

Q

Low Skew CMOS 8-Bit Buffers/Line Drivers

QS5244

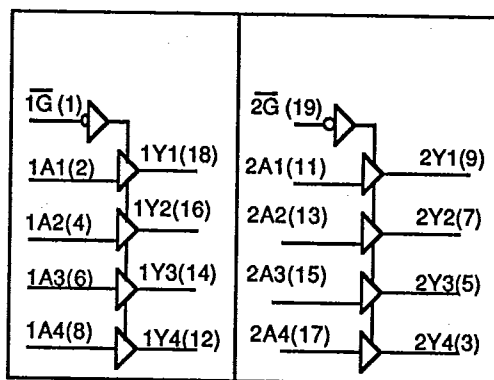
FEATURES/BENEFITS

- 0.5 ns on-chip skew (same trans.)
- 244 compatible pinout and function
- Ground bounce controlled outputs
- Reduced output swing of 0-3.5V
- Undershoot clamp diodes on all inputs
- 1.2ns on-chip skew (opposite trans.)
- 1.5ns skew between chips
- CMOS power levels: <7.5 mW static
- Available in PDIP, ZIP, SOIC, QSOP, CERDIP
- 4.1 ns propagation delay

DESCRIPTION

The QS5244 is an 8-bit buffers/line driver with three-state outputs that are ideal for driving high-capacitance loads as in memory address and data buses. All inputs have clamp diodes for undershoot noise suppression. All outputs have ground bounce suppression (see QSI Application Note AN-001), and outputs will not load an active bus when Vcc is removed from the device.

FUNCTIONAL BLOCK DIAGRAM



PINOUT

PDIP, SOIC, QSOP

$\overline{1G}$	1	20	VCC
1A1	2	19	$\overline{2G}$
2Y4	3	18	1Y1
1A2	4	17	2A4
2Y3	5	16	1Y2
1A3	6	15	2A3
2Y2	7	14	1Y3
1A4	8	13	2A2
2Y1	9	12	1Y4
GND	10	11	2A1

ALL PINS TOP VIEW

FUNCTION TABLES

$\overline{1G} / \overline{2G}$	Input A	Output Y
H	X	Z
L	L	L
L	H	H

ABSOLUTE MAXIMUM RATINGS

Supply Voltage to Ground.....	-0.5V to +7.0V
DC Output Voltage V_O	-0.5V to 7.0V
DC Input Voltage V_I	-0.5V to 7.0V
AC Input Voltage (for a pulse width ≤ 20 ns).....	-3.0V
DC Input Diode Current with $V_I < 0$	-20 mA
DC Output Diode Current with $V_O < 0$	-50 mA
DC Output Current Max. sink current/pin.....	120 mA
Maximum Power Dissipation.....	0.5 watts
T_{STG} Storage Temperature.....	-65° to +165°C

QS5244 Preliminary

CAPACITANCE

TA = 25 °C, f = 1 MHz, Vin = 0V, Vout = 0 V

Pins	SOIC	QSOP	PDIP,LCC	ZIP	Unit
1,19	4	4	5	7	pF
-----	6	6	7	9	pF
2-9,11-18	8	8	9	10	pF

Note: Capacitance is characterized but not tested

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Commercial TA=0°C to 70°C, VCC=5.0V±5%

Military TA=-55°C to 125°C, VCC=5.0V±10%

Symbol	Parameter	Test Conditions		Min	Typ (1)	Max	Unit
Vih	Input High Voltage	Logic HIGH for All Inputs		2.0	-	-	Volts
Vil	Input LOW Voltage	Logic LOW for All Inputs		-	-	0.8	
ΔVt	Input Hysteresis	Vth - Vtl for All Inputs		-	0.2	-	
lih lil	Input Current Input HIGH or LOW	Vcc = MAX	0 ≤ Vin < Vcc	-	-	5	μA
loz	Off State Output Current (Hi-Z)	Vcc = MAX, 0 ≤ Vin ≤ Vcc		-	-	5	
Ios	Short Circuit Current	Vcc = MAX, Vo = GND (2,3)		-60	-	-255	mA
Vic	Input Clamp Voltage	Vcc = MIN, Iin = 18 mA (3)		-	-0.7	-1.2	Volts
Voh	Output HIGH Voltage	Vcc = MIN	Ioh = 12 mA (MIL)	2.4	-	-	Volts
			Ioh = 15 mA (COM)	2.4	-	-	
Vol	Output LOW Voltage	Vcc = MIN	Iol = 48 mA (MIL)	-	-	0.55	
			Iol = 64 mA (COM)	-	-	0.55	

Notes:

- Typical values indicate VCC=5.0V and TA=25°C.
- Not more than one output should be shorted and the duration is ≤1 second.
- These parameters are guaranteed by design but not tested.

POWER SUPPLY CHARACTERISTICS

Symbol	Parameter	Test Conditions (1)	Min	Max	Unit
I _{cc}	Quiescent Power Supply Current	V _{cc} = MAX, freq = 0 0V ≤ V _{in} ≤ 0.2V or V _{cc} - 0.2V ≤ V _{in} ≤ V _{cc}	-	1.5	mA
ΔI _{cc}	Supply Current per Input @ TTL HIGH	V _{cc} = MAX, V _{in} = 3.4 V, freq = 0 (2)	-	2.0	
Q _{ccd}	Supply Current per input per mHz	V _{cc} = MAX, Outputs open and enabled One bit toggling @ 50% duty cycle Other inputs at GND or V _{cc} (3,4)	-	0.25	mA/ MHz

1. For conditions shown as MIN or MAX use the appropriate values specified under DC specifications.
2. Per TTL driven input (V_i = 3.4V)
3. For flipflops Q_{ccd} is measured by switching one of the data input pins so that the output changes every clock cycle. This is a measurement of device power consumption only and does not include power to drive load capacitance or tester capacitance. This parameter is guaranteed by design but not tested.
4. I_c can be computed using the above parameters as explained in the Technical Overview section.

SWITCHING CHARACTERISTICS OVER OPERATING RANGE

Commercial T_A = 0°C to 70°C, V_{CC} = 5.0V ± 5% Military T_A = -55°C to 125°C, V_{CC} = 5.0V ± 10%
 Load = 50 pF, R_{load} = 500Ω unless otherwise noted

Symbol	Description	Notes	807T		Unit	
			Min	Max		
t PHL t PLH	Propagation Delay Ai to Yi	COM	1	1.5	4.1	ns
t PZH t PZL	Output Enable Time OE to Yi	COM	1	1.5	5.6	
t PHZ t PLZ	Output Disable Time OE to Yi	COM	1,2	1.5	5.2	
tSK1	Skew between two outputs (same transition)	COM	2		0.5	
tSK2	Skew between two outputs (opposite transition, same device)	COM	2		1.2	
tSK3	Skew between two outputs of different devices	COM	2		1.5	

Notes:

1. Minimum propagation delay values are guaranteed but not tested.
2. This parameter is guaranteed but not tested.